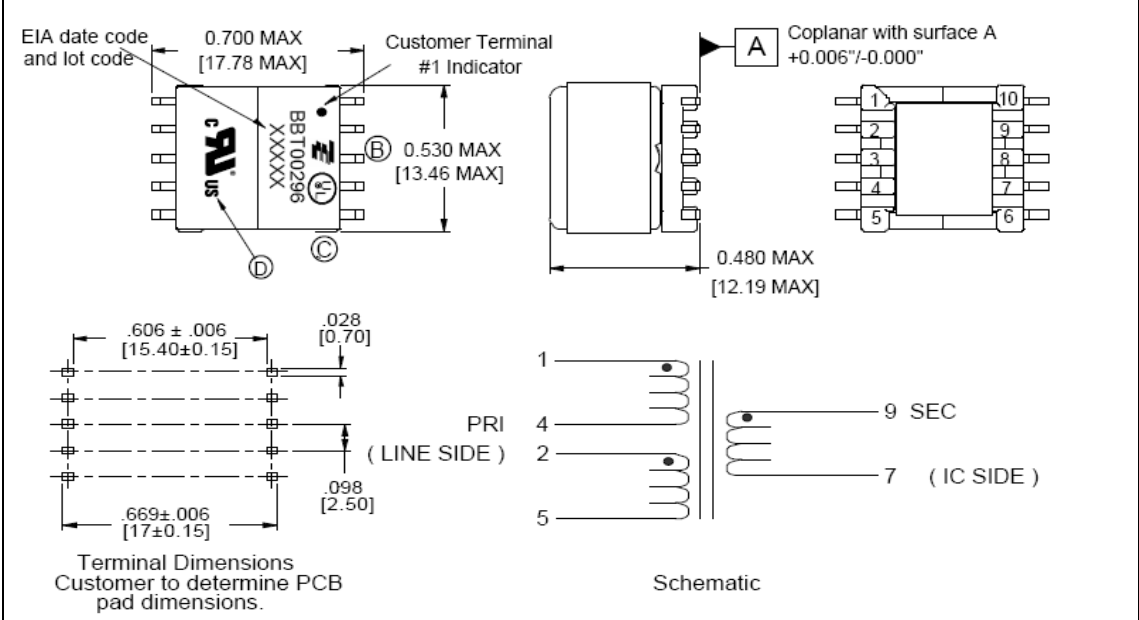


MGBBT-00296-P	REV	
3-1879385-6	BA	

Product Description **XFMR EP13 SMD, ROHS MGBBT-00114**
Previously MGBBT-00296



Primary Units are in inches millimetres in brackets

Electrical Specifications at +20°C unless noted otherwise

Test	Limits	Unit	Tol.	Notes
Inductance	3.00	mH	±10%	1-5 tie(2+4), 10kHz, 100mVAC, Ls.
Leakage Inductance	29.0	µH	Max.	1-5 tie(2+4, 9+7), 100kHz, 100mVAC,Ls.
DC Resistance	0.660	Ω	Max.	Pins 9 - 7
DC Resistance	3.30	Ω	Max.	Pins 1 - 5 tie(2 + 4)
Turns Ratio	4.5 : 1.00	--	±1%	(1-5) : (9-7) tie(2+4), 10KHz, 100mVAC
Dielectric	1,875	VAC	500µA	1-9 tie(2+4), 1 second test, 500uA maximum
Interwinding Capacitance	75.0	pF	Max.	1-9 tie(1+2+4+5, 7+9), 100kHz, 100mVAC,Cs.
Total Harmonic Distortion	-84.0	dB	Max.	10kHz, 4.0Vrms [11.31 Vp-p], Line : IC
Total Harmonic Distortion	-76.0	dB	Max.	3k (2nd Harmonic)Hz, 1.0Vrms [2.83 Vp-p], Line : IC
Total Harmonic Distortion	-84.0	dB	Max.	3k (3rd Harmonic)Hz, 1.0Vrms [2.83 Vp-p], Line : IC
Longitudinal Balance (ITU)	55.0	dB	Min.	5kHz - 400kHz.

Terminal Plating is Hot-dipped SnAgCu over Ni
260°C Maximum wave solder temperature per J-STD-020
Operating Temperature range -40°C to +85°C



Meets requirements of IEC60950 for basic insulation, 250V working voltage
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Specifications subject to change without notice. For latest revision visit <http://www.tycoelectronics.com>
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